

**P-channel -60V, -50A, TO-252 Trench Power MOSFET 溝槽式功率場效應管**

**■Features 特點**

Low on-resistance and maximum DC current capability 低導通電阻和最大直流電流能力

Super high density cell design 超高元胞密度設計

$R_{DS(ON)} \leq 28m\Omega @ VGS = -10V$

**■Applications 應用**

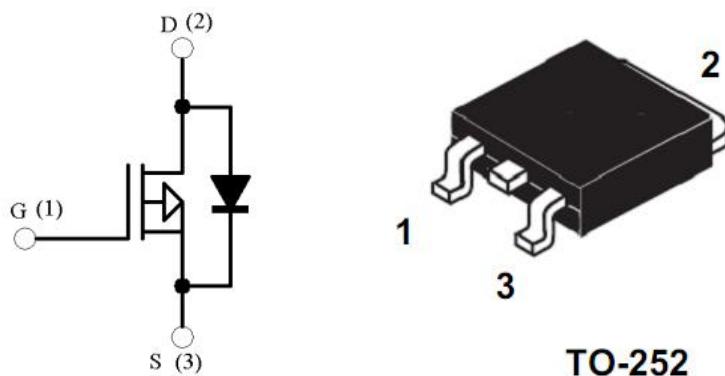
Power Management in Note book 筆記本電源管理

Portable Equipment 便攜式設備

Battery Powered System 電池電源系統

Load Switch 負載開關應用

**■Internal Schematic Diagram 內部結構**



**■Absolute Maximum Ratings 最大額定值**

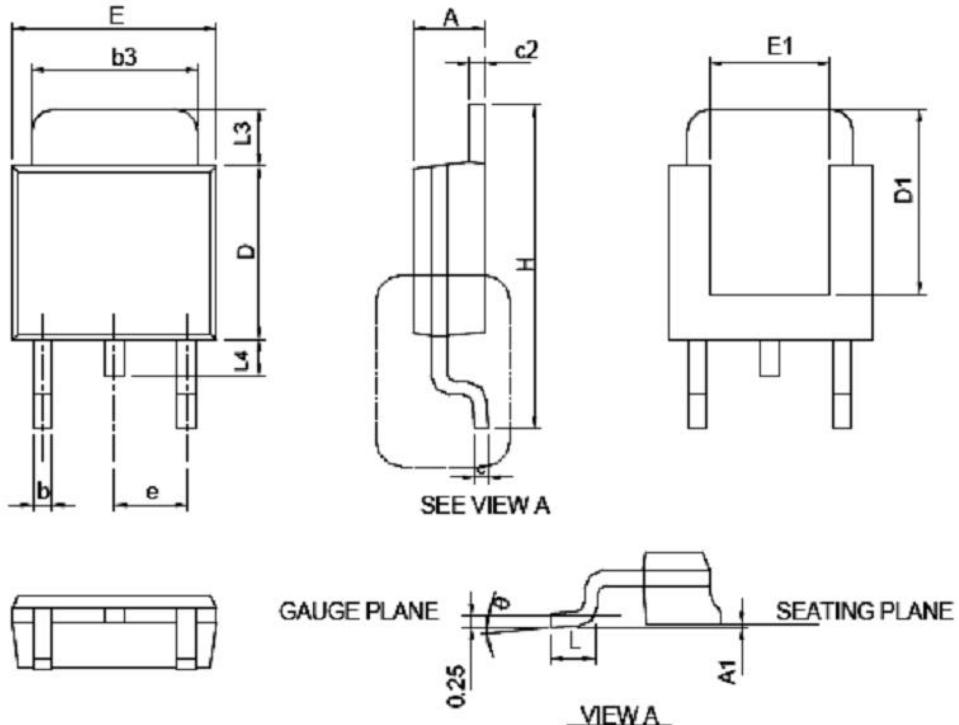
Characteristic 特性參數	Symbol 符號	Rating 額定值	Unit 單位
Drain-Source Voltage 漏極-源極電壓	$BV_{DSS}$	-60	V
Gate- Source Voltage 柵極-源極電壓	$V_{GS}$	$\pm 20$	V
Drain Current (continuous) 漏極電流-連續	$I_D$ (at $T_A = 25^\circ C$ )	-50	A
Drain Current (pulsed) 漏極電流-脉冲	$I_{DM}$	-150	A
Total Device Dissipation 總耗散功率	$P_{TOT}$	95	W
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}$	1.5	$^\circ C/W$
Avalanche energy, single pulsed 雪崩能量	EAS	720	mJ
Junction/Storage Temperature 結溫/儲存溫度	$T_J, T_{stg}$	-55~150	$^\circ C$

■ Electrical Characteristics 電特性

( $T_A=25^\circ\text{C}$  unless otherwise noted 如無特殊說明，溫度為  $25^\circ\text{C}$ )

Characteristic 特性參數	Symbol 符號	Min 最小值	Typ 典型值	Max 最大值	Unit 單位
Drain-Source Breakdown Voltage 漏極-源極擊穿電壓( $I_D = -250\mu\text{A}, V_{GS} = 0\text{V}$ )	$\text{BV}_{DSS}$	-60	—	—	V
Gate Threshold Voltage 柵極開啓電壓( $I_D = -250\mu\text{A}, V_{GS} = V_{DS}$ )	$V_{GS(\text{th})}$	-2	-2.6	-4	V
Zero Gate Voltage Drain Current 零柵壓漏極電流( $V_{GS} = 0\text{V}, V_{DS} = -60\text{V}$ )	$I_{DSS}$	—	—	-1	$\mu\text{A}$
Gate Body Leakage 柵極漏電流( $V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$ )	$I_{GSS}$	—	—	$\pm 100$	nA
Static Drain-Source On-State Resistance 靜態漏源導通電阻( $I_D = -20\text{A}, V_{GS} = -10\text{V}$ )	$R_{DS(\text{ON})}$	—	23	28	$\text{m}\Omega$
Diode Forward Voltage Drop 內附二極管正向壓降( $I_{SD} = -20\text{A}, V_{GS} = 0\text{V}$ )	$V_{SD}$	—	—	-1.2	V
Input Capacitance 輸入電容 ( $V_{GS} = 0\text{V}, V_{DS} = -25\text{V}, f = 1\text{MHz}$ )	$C_{ISS}$	—	6300	—	pF
Common Source Output Capacitance 共源輸出電容( $V_{GS} = 0\text{V}, V_{DS} = -25\text{V}, f = 1\text{MHz}$ )	$C_{OSS}$	—	680	—	pF
Reverse Transfer Capacitance 反向傳輸電容 ( $V_{GS} = 0\text{V}, V_{DS} = -25\text{V}, f = 1\text{MHz}$ )	$C_{RSS}$	—	500	—	pF
Total Gate Charge 總柵極電荷密度 ( $V_{DS} = -30\text{V}, I_D = -20\text{A}, V_{GS} = -10\text{V}$ )	$Q_g$	—	70	—	nC
Gate Source Charge 柵源電荷密度 ( $V_{DS} = -30\text{V}, I_D = -20\text{A}, V_{GS} = -10\text{V}$ )	$Q_{gs}$	—	15	—	nC
Gate Drain Charge 柵漏電荷密度 ( $V_{DS} = -30\text{V}, I_D = -20\text{A}, V_{GS} = -10\text{V}$ )	$Q_{gd}$	—	18	—	nC
Turn-On Delay Time 開啓延遲時間 ( $V_{DS} = -30\text{V}, I_D = -20\text{A}, R_{GEN} = 3\Omega, V_{GS} = -10\text{V}$ )	$t_{d(on)}$	—	15	—	ns
Turn-On Rise Time 開啓上升時間 ( $V_{DS} = -30\text{V}, I_D = -20\text{A}, R_{GEN} = 3\Omega, V_{GS} = -10\text{V}$ )	$t_r$	—	17	—	ns
Turn-Off Delay Time 關斷延遲時間 ( $V_{DS} = -30\text{V}, I_D = -20\text{A}, R_{GEN} = 3\Omega, V_{GS} = -10\text{V}$ )	$t_{d(off)}$	—	40	—	ns
Turn-On Fall Time 開啓下降時間 ( $V_{DS} = -30\text{V}, I_D = -20\text{A}, R_{GEN} = 3\Omega, V_{GS} = -10\text{V}$ )	$t_f$	—	45	—	ns

■DIMENSION 外形封裝尺寸



SYMBOL	TO-252			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	2.18	2.39	0.086	0.094
A1		0.13		0.005
b	0.50	0.89	0.020	0.035
b3	4.95	5.46	0.195	0.215
c	0.46	0.61	0.018	0.024
c2	0.46	0.89	0.018	0.035
D	5.33	6.22	0.210	0.245
D1	4.57	6.00	0.180	0.236
E	6.35	6.73	0.250	0.265
E1	3.81	6.00	0.150	0.236
e	2.29 BSC		0.090 BSC	
H	9.40	10.41	0.370	0.410
L	0.90	1.78	0.035	0.070
L3	0.89	2.03	0.035	0.080
L4		1.02		0.040
0	0°	8°	0°	8°